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## **Supporting Information**

## Vertically Aligned Nanorods Fe<sub>2</sub>TiO<sub>5</sub> and Coupling of NiMoO<sub>4</sub>/CoMoO<sub>4</sub> as A Hole-Transfer

## **Cocatalyst for Enhancing Photoelectrochemical Water Oxidation Performance**

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**Figure S1.** (a) Equivalent circuit (EC) for the charge transfer process of Fe<sub>2</sub>TiO<sub>5</sub> composite photoanode under dark,  $R_s$ , resistance associated with the electric contact of the electrode, electrolyte, etc.  $C_{bulk}$ , Bulk capacitance of Fe<sub>2</sub>TiO<sub>5</sub> related to charge accumulation.  $R_{ct \ bulk}$ , Resistance of hole transfer from Fe<sub>2</sub>TiO<sub>5</sub> composite photoanode to water molecule. there is no surface states mediated process under dark. (b) Equivalent circuit (EC) for the charge transfer process of Fe<sub>2</sub>TiO<sub>5</sub> composite photoanode under illumination, the Fe<sub>2</sub>TiO<sub>5</sub> SEI is mediated by surface states.  $R_s$ , resistance associated with the electric contacts of the electrode, electrolyte, etc.  $C_{bulk}$ , Bulk capacitance of Fe<sub>2</sub>TiO<sub>5</sub> related to charge accumulation.  $R_{trap}$ , Surface state hole trapping resistance.  $R_{ct \ trap}$ , Resistance of hole transfer from surface state to water molecule.  $C_{trap}$ , Surface state charge accumulation capacitance.



**Figure S2.** (a) precursor solution concentration, (b) hydrothermal time and (c) ratio of iron to titanium atoms in precursor solution optimization process shown in J-V curves. The optimization results were 36 mM,18 h,2:1, respectively.



**Figure S3.** (a) precursor solution concentration, (b) hydrothermal time, (c) ratio of cobalt to nickel atoms in precursor solution and (d) species of cobalt and nickel atoms in precursor solutions optimization process shown in J-V curves. The optimization results were 5mM, 20min, CoNi-11, NiMoO<sub>4</sub>/ CoMoO<sub>4</sub>.



Figure S4. XPS spectrum of (a) C1s, (b) XPS survey spectrum of Fe<sub>2</sub>TiO<sub>5</sub>/NiMoO<sub>4</sub>/CoMoO<sub>4</sub>.



Figure S5. SEM image of TiO<sub>2</sub> nanorods.



Figure S6. SEM images of (a) cross-sectional of Fe<sub>2</sub>TiO<sub>5</sub> nanorods, (b) Fe<sub>2</sub>TiO<sub>5</sub>/NiMoO<sub>4</sub>/ CoMoO<sub>4</sub> and (c)

cross-sectional of  $Fe_2TiO_5/NiMoO_4/CoMoO_4$ .



Figure S7. SEM images of Fe<sub>2</sub>TiO<sub>5</sub>/NiMoO<sub>4</sub>/CoMoO<sub>4</sub> (a) before and (b) after 2 hours of stability



**Figure S8.** J–V curves of Fe<sub>2</sub>TiO<sub>5</sub> thin film, Fe<sub>2</sub>TiO<sub>5</sub> nanorods and Fe<sub>2</sub>TiO<sub>5</sub>/NiMoO<sub>4</sub>/CoMoO<sub>4</sub> in 1.0 M KOH with and without 0.5M Na<sub>2</sub>SO<sub>3</sub> under AM 1.5 G irradiation.



Figure S9. Nyquist plots under light illumination of (a)  $Fe_2TiO_5$  thin film, (b)  $Fe_2TiO_5$  nanorods and (c)  $Fe_2TiO_5/NiMoO_4/CoMoO_4$  at 0.7, 0.75, 0.8, 0.85, 0.9, 0.95, 1.0, 1.05, 1.1, 1.15, 1.2 V<sub>RHE</sub>.



**Figure S10.** (a)  $R_s$ , (b)  $C_{bulk}$  fitting values from the impedance response of the Fe<sub>2</sub>TiO<sub>5</sub> thin film, Fe<sub>2</sub>TiO<sub>5</sub> nanorods and Fe<sub>2</sub>TiO<sub>5</sub>/NiMoO<sub>4</sub>/CoMoO<sub>4</sub> under AM 1.5 G illumination.

As Figure S9. (a) shown the values of  $R_s$  follow this order: Fe<sub>2</sub>TiO<sub>5</sub> thin film> Fe<sub>2</sub>TiO<sub>5</sub> nanorods> Fe<sub>2</sub>TiO<sub>5</sub>/NiMoO<sub>4</sub>/CoMoO<sub>4</sub>. The results reflected that nanorods allowed directional electron transport to the back substrates more easily than flat films, reducing contact resistance. After loading the NiMoO<sub>4</sub>/CoMoO<sub>4</sub>, not only the backside contact resistance, but also the contact resistance between the composite photoanode and electrolyte was greatly reduced, and Rs was greatly reduced. Figure S9. (b) showed that Fe<sub>2</sub>TiO<sub>5</sub>/NiMoO<sub>4</sub>/CoMoO<sub>4</sub> and Fe<sub>2</sub>TiO<sub>5</sub> thin film had similar C<sub>bulk</sub> values, but Fe<sub>2</sub>TiO<sub>5</sub> thin film had the lowest photoelectric response. This may be the fact that all the holes of Fe<sub>2</sub>TiO<sub>5</sub> thin film were concentrated in the bulk of Fe<sub>2</sub>TiO<sub>5</sub> thin film, resulting in serious bulk recombination. This viewpoint had also been verified when discussing the R<sub>trap</sub>, R<sub>ct trap</sub>, C<sub>trap</sub> and DOS.